

IRFSL4410ZPBF-VB Datasheet N-Channel 100-V (D-S) 175 °C MOSFET

| PRODUCT SUMMARY | | | | |
|---------------------|----------------------------------|--------------------|--|--|
| V _{DS} (V) | $R_{DS(on)}(\Omega)$ | I _D (A) | | |
| 100 | 0.0085 at V _{GS} = 10 V | 100 | | |
| | 0.010 at V _{GS} = 6 V | 85 | | |

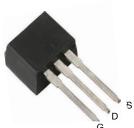
FEATURES

- Trench Power MOSFET
- 175 °C Maximum Junction Temperature

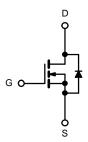








Top View



N-Channel MOSFET

| ABSOLUTE MAXIMUM RATINGS T _A = 25 °C, unless otherwise noted | | | | | |
|---|--|-----------------|------------------|---------------------------------------|--|
| Parameter | | | Limit | Unit | |
| Drain-Source Voltage | | | 100 | V | |
| Gate-Source Voltage | | | ± 20 | V | |
| Continuous Drain Current (T _{.1} = 150 °C) | T _C = 25 °C | I _D | 100 | | |
| Continuous Diam Guilent (1) = 130 C) | T _C = 125 °C | | 75 ^a | ^ | |
| Pulsed Drain Current | I _{DM} | 300 | Α | | |
| Avalanche Current | L = 0.1 mH | I _{AS} | 75 | | |
| Single Pulse Avalanche Energy ^b | L = 0.1 IIII I | E _{AS} | 280 | mJ | |
| Maximum Power Dissipation ^b | T _C = 25 °C (TO-220AB and TO-263) | P _D | 250 ^c | W | |
| | T _A = 25 °C (TO-263) ^d | | 3.75 | \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ | |
| Operating Junction and Storage Temperature Range | | T_J, T_{stg} | - 55 to 175 | °C | |

| THERMAL RESISTANCE RATINGS | | | | | |
|----------------------------|---------------------------------|-------------------|-------|------|--|
| Parameter | | Symbol | Limit | Unit | |
| Junction-to-Ambient | PCB Mount (TO-263) ^d | R _{thJA} | 40 | °C/W | |
| Junction-to-Ambient | Free Air (TO-220AB) | | 62.5 | | |
| Junction-to-Case | | R_{thJC} | 0.6 | | |

Notes

- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



| Parameter | Symbol | Test Conditions | Min. | Тур. | Max. | Unit | |
|---|-----------------------------|---|------|--------|-------|------|--|
| Static | | | • | • | | | |
| Drain-Source Breakdown Voltage | V _{DS} | $V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$ | 100 | | | V | |
| Gate-Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_D = 250 \mu A$ | | | 3 | V | |
| Gate-Body Leakage | I _{GSS} | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$ | | | ± 100 | nA | |
| | | V _{DS} = 100 V, V _{GS} = 0 V | | | 1 | | |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} = 100 V, V _{GS} = 0 V, T _J = 125 °C | | | 50 | μΑ | |
| | | V _{DS} = 100 V, V _{GS} = 0 V, T _J = 175 °C | | | 250 | 1 | |
| On-State Drain Current ^a | I _{D(on)} | $V_{DS} = \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$ | 120 | | | Α | |
| | | V _{GS} = 10 V, I _D = 30 A | | 0.0085 | | Ω | |
| D | D | V _{GS} = 4.5 V, I _D = 20 A | | 0.010 | | | |
| Drain-Source On-State Resistance ^a | H _{DS(on)} | V _{GS} = 10 V, I _D = 30 A, T _J = 125 °C | | 0.017 | | | |
| | | V _{GS} = 10 V, I _D = 30 A, T _J = 175 °C | | 0.022 | | | |
| Forward Transconductance ^a | 9 _{fs} | V _{DS} = 15 V, I _D = 30 A | 25 | | | S | |
| Dynamic ^b | | | | | | | |
| Input Capacitance | C _{iss} | V _{GS} = 0 V, V _{DS} = 25 V, f = 1 MHz | | 6550 | | pF | |
| Output Capacitance | C _{oss} | | | 665 | | | |
| Reverse Transfer Capacitance | C _{rss} |] | | 265 | | | |
| Total Gate Charge ^c | Q_g | | | 105 | 160 | | |
| Gate-Source Charge ^c | Q_{gs} | $V_{DS} = 50 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 85 \text{ A}$ | | 17 | | nC | |
| Gate-Drain Charge ^c | Q_{gd} | 7 | | 23 | | | |
| Turn-On Delay Time ^c | t _{d(on)} | | | 12 | 25 | | |
| Rise Time ^c | t _r | $V_{DD} = 50 \text{ V}, R_{L} = 0.6 \Omega$ | | 90 | 135 | | |
| Turn-Off DelayTime ^c | t _{d(off)} | $I_D\cong 85~A,~V_{GEN}=10~V,~R_g=2.5~\Omega$ | | 55 | 85 | ns | |
| Fall Time ^c | t _f | 7 | | 130 | 195 | 1 | |
| Source-Drain Diode Ratings and Cha | racteristics T _C | = 25 °C ^b | • | • | | | |
| Continuous Current | I _S | | | | 85 | ^ | |
| Pulsed Current | I _{SM} | | | | 240 | Α | |
| Forward Voltage ^a | V _{SD} | I _F = 85 A, V _{GS} = 0 V | | 1.0 | 1.5 | V | |
| Reverse Recovery Time | t _{rr} | | | 85 | 140 | ns | |
| Peak Reverse Recovery Current | I _{RM(REC)} | I _F = 50 A, dI/dt = 100 A/μs | | 4.5 | 7 | Α | |
| Reverse Recovery Charge | Q _{rr} | | | 0.17 | 0.35 | μC | |

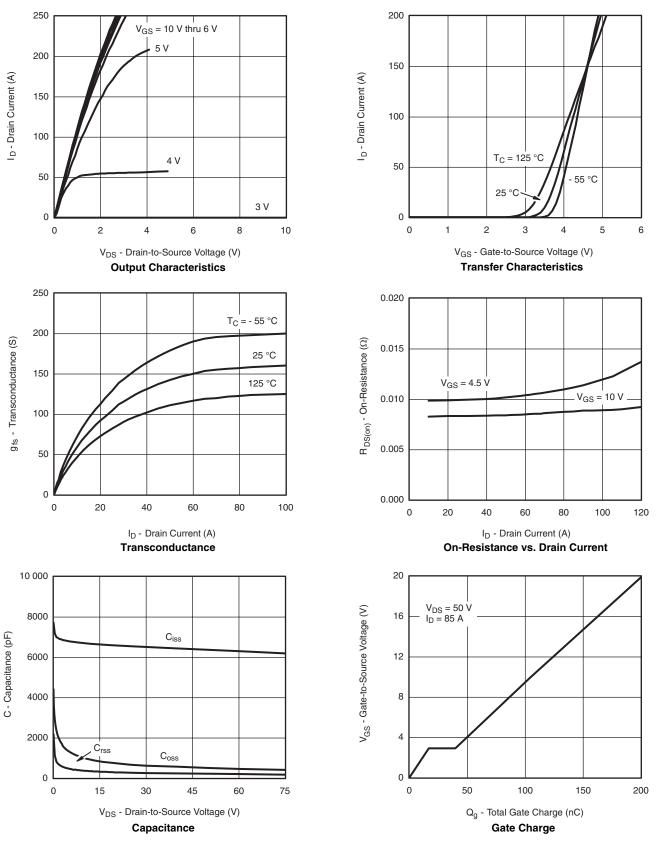
Notes:

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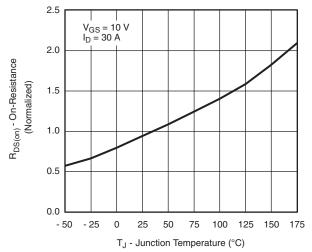


TYPICAL CHARACTERISTICS $T_A = 25 \, ^{\circ}C$, unless otherwise noted

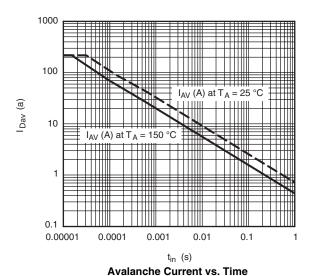




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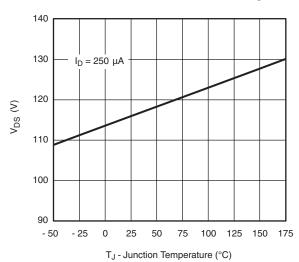


On-Resistance vs. Junction Temperature



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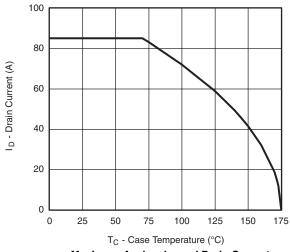
Source-Drain Diode Forward Voltage

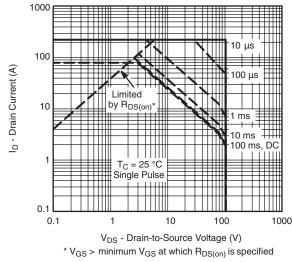


T_J - Drain-Source Breakdown vs. Junction-Temperature



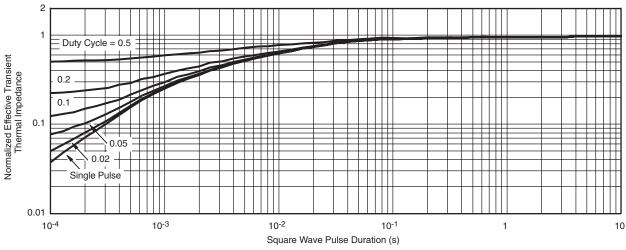
THERMAL RATINGS





Maximum Avalanche and Drain Current vs. Case Temperature

Safe Operating Area



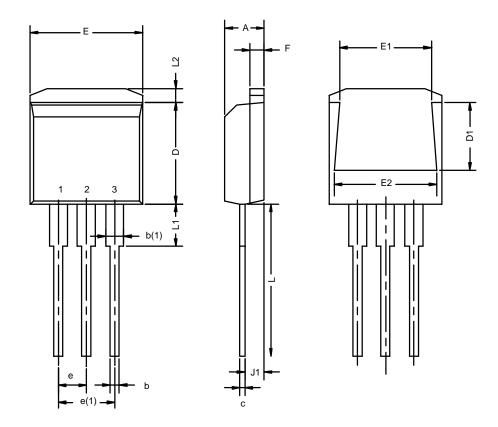
Normalized Thermal Transient Impedance, Junction-to-Case

服务热线:400-655-8788

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TO-262: 3-LEAD



| | MILLIMETERS* | | INC | HES | |
|---|--------------|-------|-------|-------|--|
| Dim | Min | Max | Min | Max | |
| Α | 4.32 | 4.70 | 0.170 | 0.185 | |
| b | 0.64 | 1.00 | 0.025 | 0.039 | |
| b(1) | 1.14 | 1.40 | 0.045 | 0.055 | |
| С | 0.36 | 0.50 | 0.014 | 0.020 | |
| D | 8.64 | 9.65 | 0.340 | 0.380 | |
| D1 | 5.59 | 6.10 | 0.220 | 0.240 | |
| е | 2.41 | 2.67 | 0.095 | 0.105 | |
| e(1) | 4.95 | 5.33 | 0.195 | 0.210 | |
| E | 10.03 | 10.41 | 0.395 | 0.410 | |
| E1 | 7.87 | 8.64 | 0.310 | 0.340 | |
| E2 | 9.02 | 9.53 | 0.355 | 0.375 | |
| F | 1.14 | 1.40 | 0.045 | 0.055 | |
| J1 | 2.41 | 2.79 | 0.095 | 0.110 | |
| L | 13.08 | 14.22 | 0.515 | 0.560 | |
| L1 | - | 3.81 | - | 0.150 | |
| L2 | 1.02 | 1.40 | 0.040 | 0.055 | |
| ECN: T-02234—Rev. C, 14-Oct-02 DWG: 5855 | | | | | |

^{*}Use millimeters as the primary measurement



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